

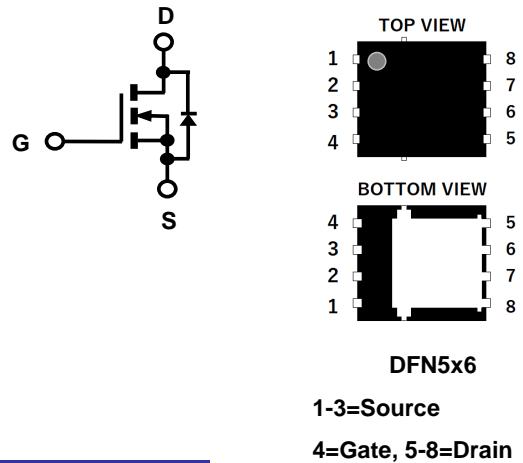
# ICE6N60LK N-Channel Enhancement Mode MOSFET

## Features

- Low  $r_{DS(on)}$
- Ultra Low Gate Charge
- High dv/dt capability
- High Unclamped Inductive Switching (UIS) capability
- High peak current capability
- Increased transconductance performance
- Optimized design for high performance power systems



Product Summary			
$I_D$	$T_A=25^\circ\text{C}$	6A	Max
$V_{(\text{BR})\text{DSS}}$	$I_D=250\mu\text{A}$	600V	Min
$r_{DS(\text{on})}$	$V_{GS}=10\text{V}$	0.60	Typ
$Q_g$	$V_{DS}=480\text{V}$	28nC	Typ



ICEMOS OWNS THE FUNDAMENTAL PATENTS FOR SUPERJUNCTION MOSFETS. THE MAJORITY OF THESE PATENTS HAVE 17 to 20 YEARS OF REMAINING LIFE. THIS PORTFOLIO HAS GRANTED PATENTS ISSUED IN USA, CHINA, KOREA, JAPAN, TAIWAN & EUROPE.

**Maximum ratings<sup>b</sup>** at  $T_j=25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	$I_D$	$T_c=25^\circ\text{C}$	6	A
		$T_c=100^\circ\text{C}$	4	
Pulsed drain current	$I_{D, \text{pulse}}$	$T_c=25^\circ\text{C}$	18	A
Avalanche energy, single pulse	$E_{AS}$	$I_D=4.8\text{A}$	115	mJ
Avalanche current, repetitive	$I_{AR}$	limited by $T_j\text{max}$	4.8	A
MOSFET dv/dt ruggedness	dv/dt	$V_{DS}=480\text{V}$ , $I_D=6\text{A}$ , $T_j=125^\circ\text{C}$	50	V/ns
Gate source voltage	$V_{GS}$	Static	$\pm 20$	V
		AC ( $f>1\text{Hz}$ )	$\pm 30$	
Power dissipation	$P_{\text{tot}}$	$T_c=25^\circ\text{C}$	78	W
Operating and storage temperature	$T_j$ , $T_{stg}$		-55 to +150	°C

a When mounted on 1inch square 2oz copper clad FR-4

b limited by  $T_{jmax}$

<b>Parameter</b>	<b>Symbol</b>	<b>Conditions</b>	<b>Values</b>			<b>Unit</b>
			<b>Min</b>	<b>Typ</b>	<b>Max</b>	

**Thermal characteristics**

Thermal resistance, junction-case <sup>a</sup>	$R_{\text{thJC}}$		-	-	1.6	°C/W
Thermal resistance, junction-ambient <sup>a</sup>	$R_{\text{thJA}}$	leaded	-	-	62	
Soldering temperature, wave soldering only allowed at leads	$T_{\text{sold}}$	1.6mm (0.063in.) from case for 10 s	-	-	260	°C

**Electrical characteristics** at  $T_j=25^\circ\text{C}$ , unless otherwise specified

**Static characteristics**

Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}}=0 \text{ V}, I_D=250\mu\text{A}$	600	640	-	V
Gate threshold voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_D=250\mu\text{A}$	2.1	3.0	3.9	
Zero gate voltage drain current	$I_{\text{DSS}}$	$V_{\text{DS}}=600\text{V}, V_{\text{GS}}=0\text{V}, T_j=25^\circ\text{C}$	-	0.1	1	μA
		$V_{\text{DS}}=600\text{V}, V_{\text{GS}}=0\text{V}, T_j=150^\circ\text{C}$	-	100	-	
Gate source leakage current	$I_{\text{GSS}}$	$V_{\text{GS}}=\pm 20 \text{ V}, V_{\text{DS}}=0\text{V}$	-	-	100	nA
Drain-source on-state resistance	$R_{\text{DS} (\text{on})}$	$V_{\text{GS}}=10\text{V}, I_D=3\text{A}, T_j=25^\circ\text{C}$	-	0.60	0.70	Ω
		$V_{\text{GS}}=10\text{V}, I_D=3\text{A}, T_j=150^\circ\text{C}$	-	1.60	-	
Gate resistance	$R_G$	$f=1 \text{ MHZ}, \text{open drain}$	-	<b>3.8</b>	-	Ω

**Dynamic characteristics**

Input capacitance	$C_{\text{iss}}$	$V_{\text{GS}}=0 \text{ V}, f=1 \text{ MHz}$	$V_{\text{DS}}=25 \text{ V}$	-	579	-	pF
Output capacitance	$C_{\text{oss}}$		$V_{\text{DS}}=100 \text{ V}$	-	26	-	
Reverse transfer capacitance	$C_{\text{rss}}$		$V_{\text{DS}}=25 \text{ V}$	-	12	-	
Transconductance	$g_{\text{fs}}$	$V_{\text{DS}}>2 * I_D * R_{\text{DS}}, I_D=3\text{A}$		-	4	-	S
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{DS}}=380\text{V}, V_{\text{GS}}=10\text{V}, I_D=3\text{A}, R_G=4\Omega \text{ (External)}$	-	14	-	ns	
Rise time	$t_r$		-	6	-		
Turn-off delay time	$t_{\text{d}(\text{off})}$		-	42	-		
Fall time	$t_f$		-	5.2	-		

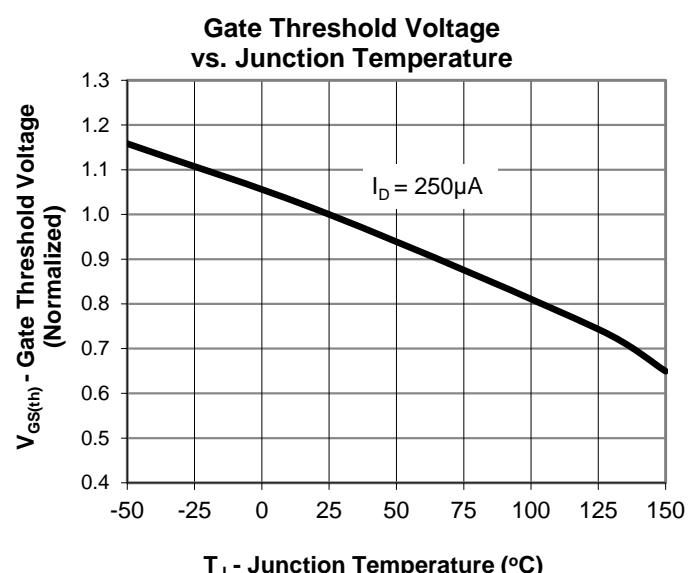
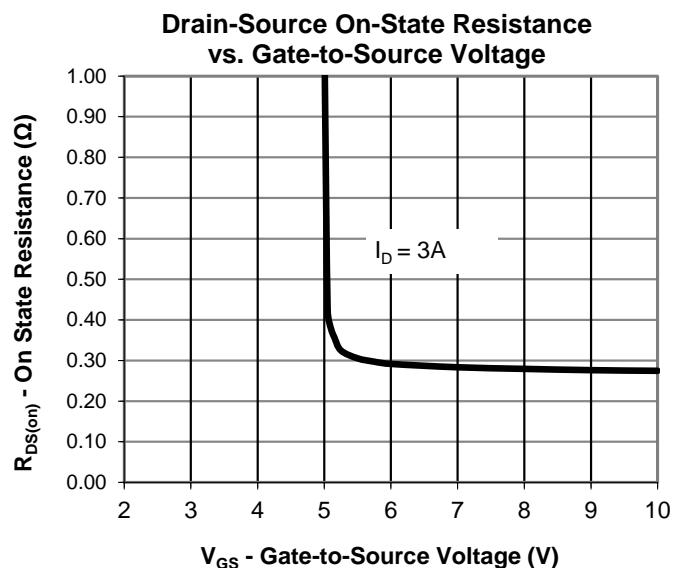
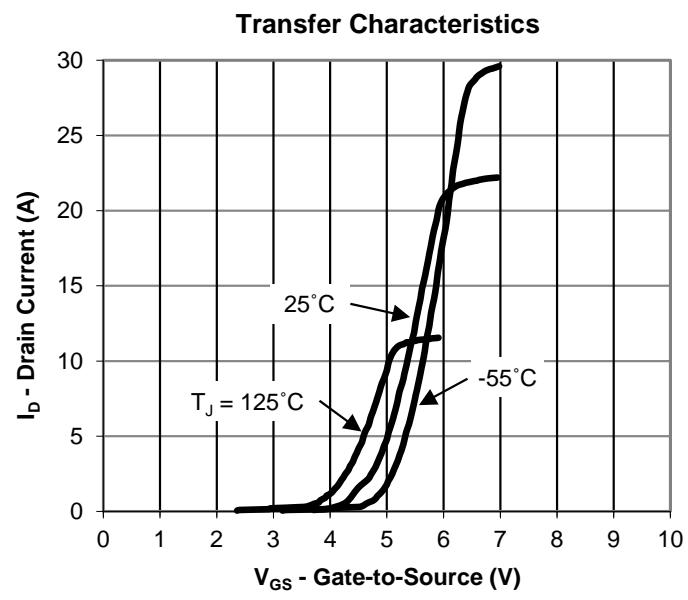
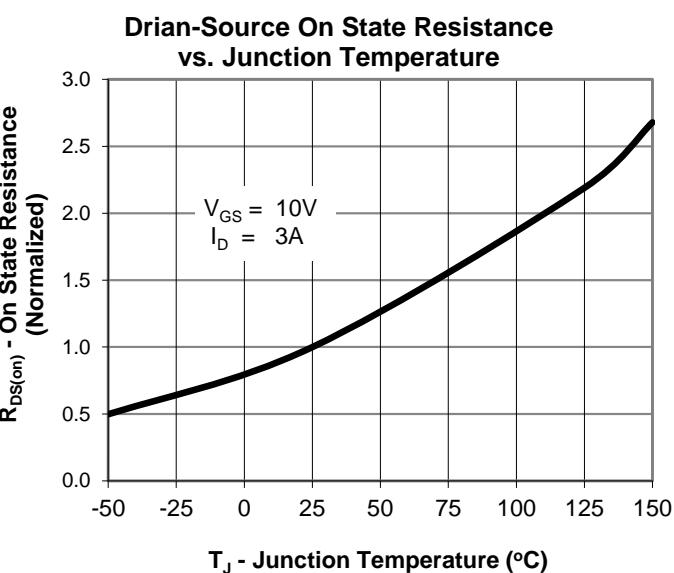
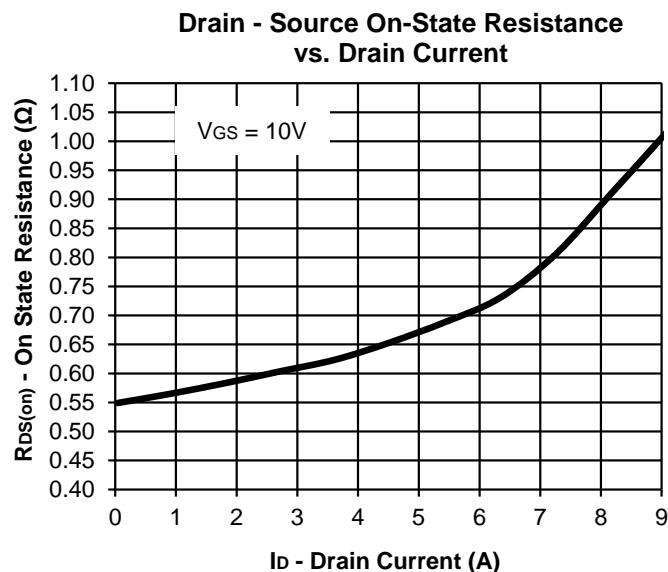
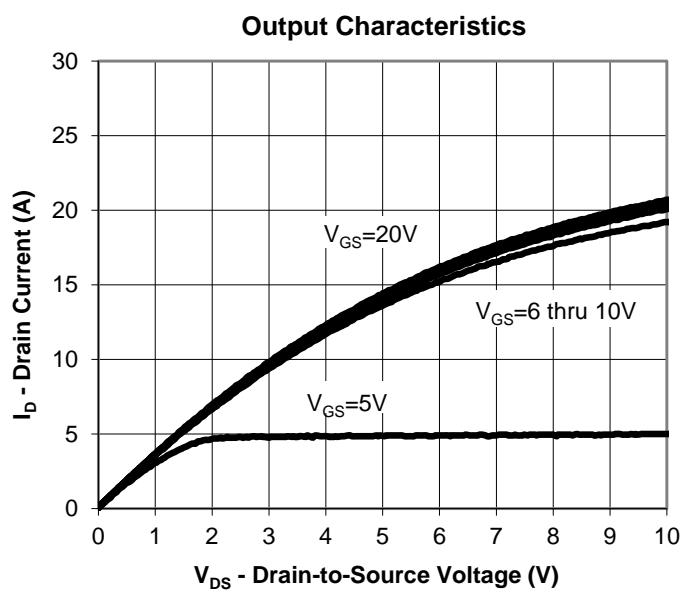
<b>Parameter</b>	<b>Symbol</b>	<b>Conditions</b>	<b>Values</b>			<b>Unit</b>
			<b>Min</b>	<b>Typ</b>	<b>Max</b>	

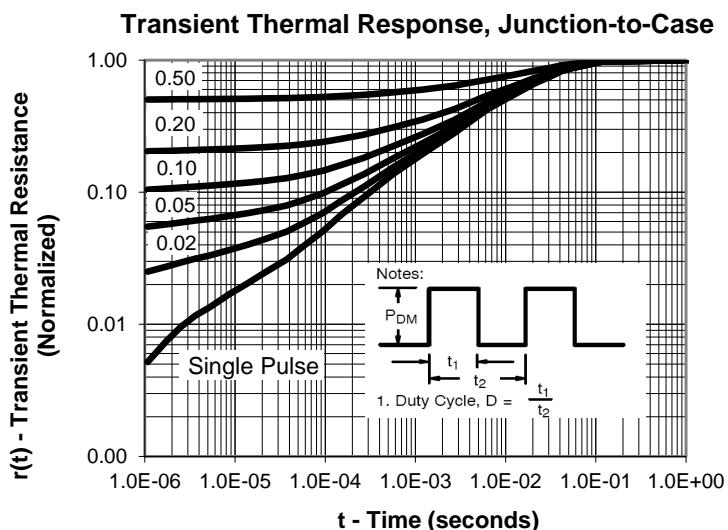
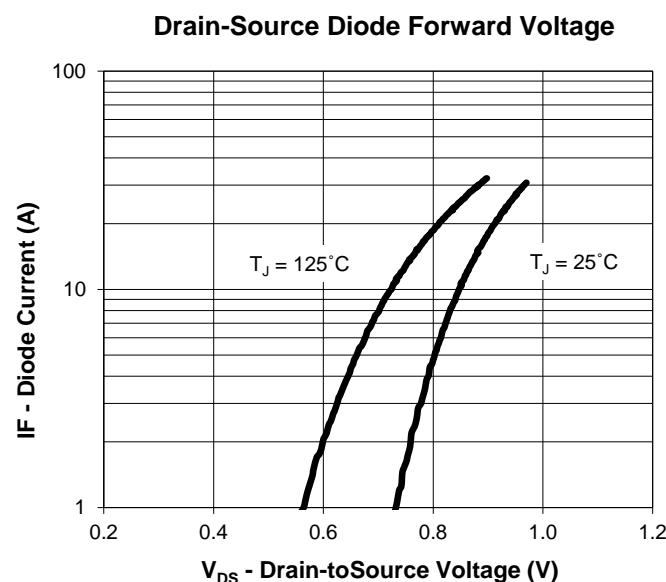
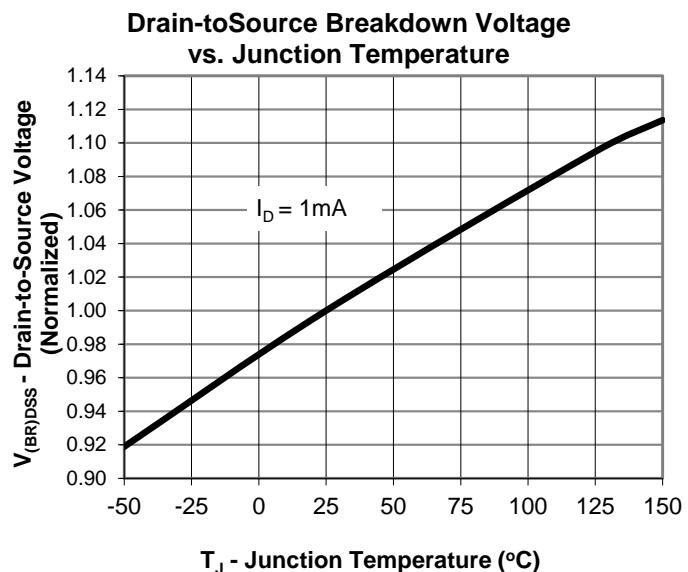
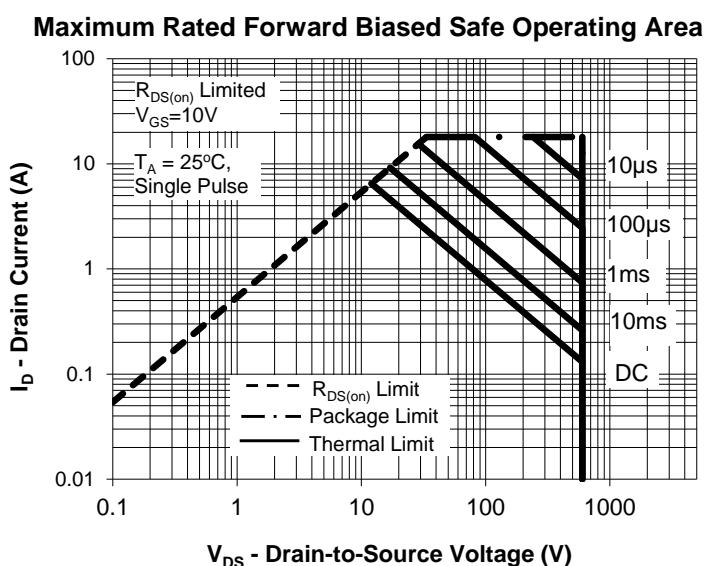
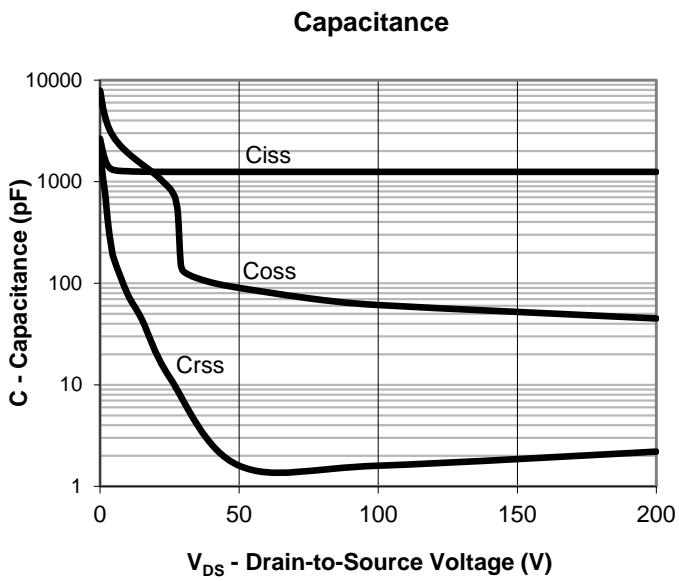
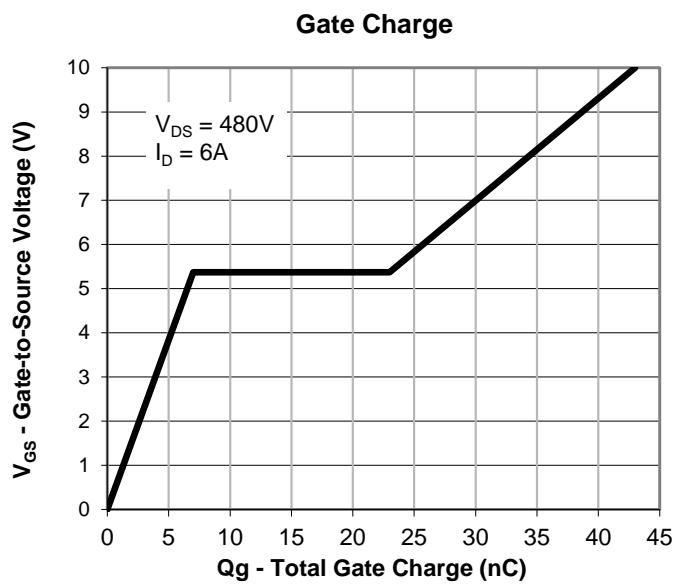
**Gate charge characteristics**

Gate to source charge	$Q_{gs}$	$V_{DS}=480\text{ V}, I_D=6\text{A}, V_{GS}=0\text{ to }10\text{ V}$	-	3	-	nC
Gate to drain charge	$Q_{gd}$		-	7	-	
Gate charge total	$Q_g$		-	28	-	
Gate plateau voltage	$V_{plateau}$		-	5.4	-	V

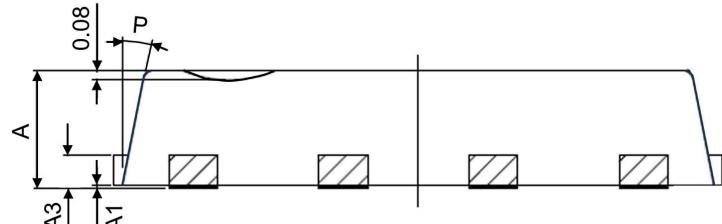
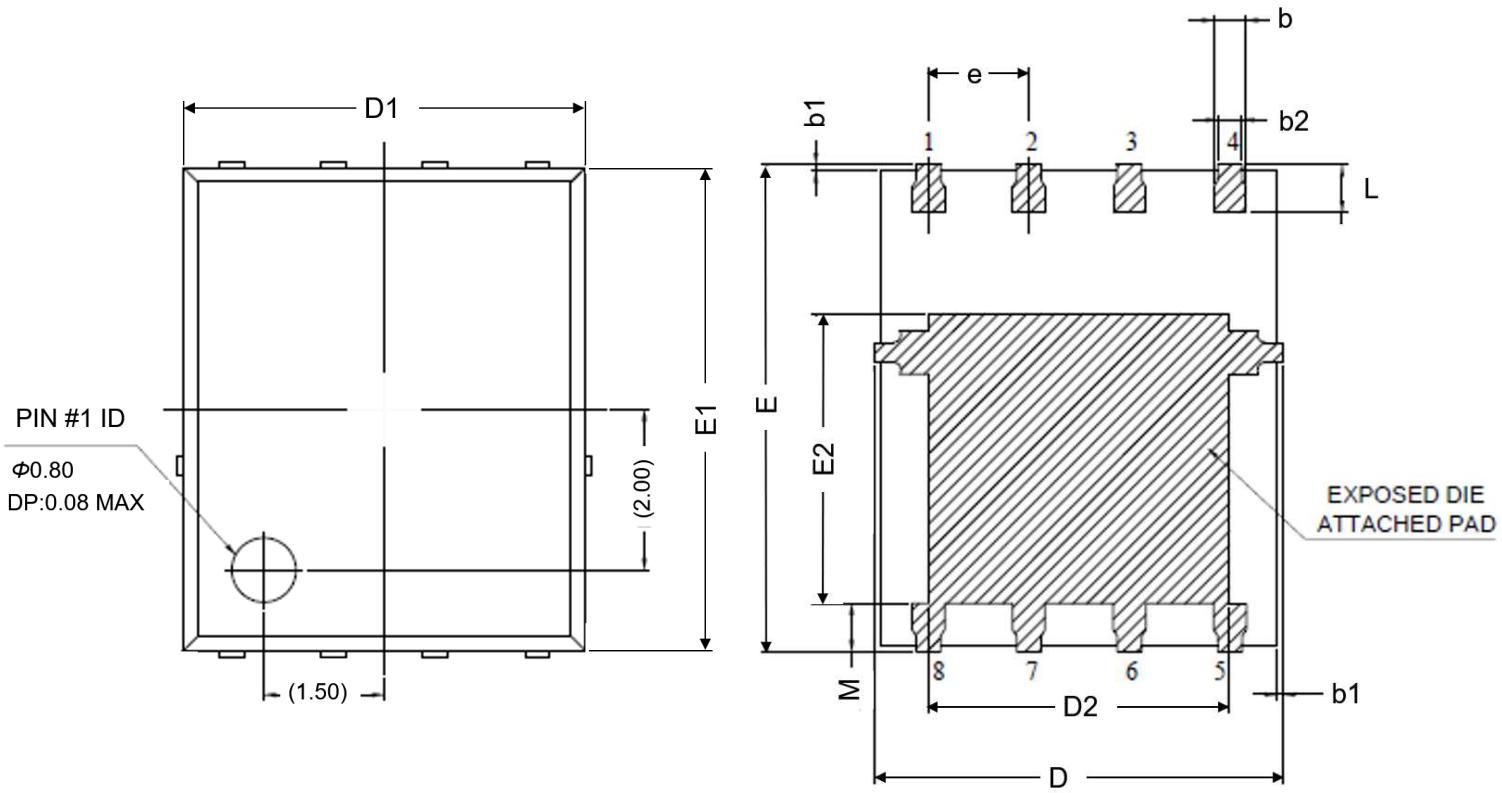
**Reverse Diode**

Continuous forward current	$I_S$	$V_{GS}=0\text{V}$	-	-	6	A
Diode forward voltage	$V_{SD}$	$V_{GS}=0\text{V}, I_S=I_F$	-	0.9	1.2	V
Reverse recovery time	$t_{rr}$	$V_{RR}=300\text{V}, I_S=I_F, d_iF/d_t=100\text{ A}/\mu\text{s}$	-	228	-	ns
Reverse recovery charge	$Q_{rr}$		-	2.4	-	$\mu\text{C}$
Peak reverse recovery current	$I_{rm}$		-	29	-	A



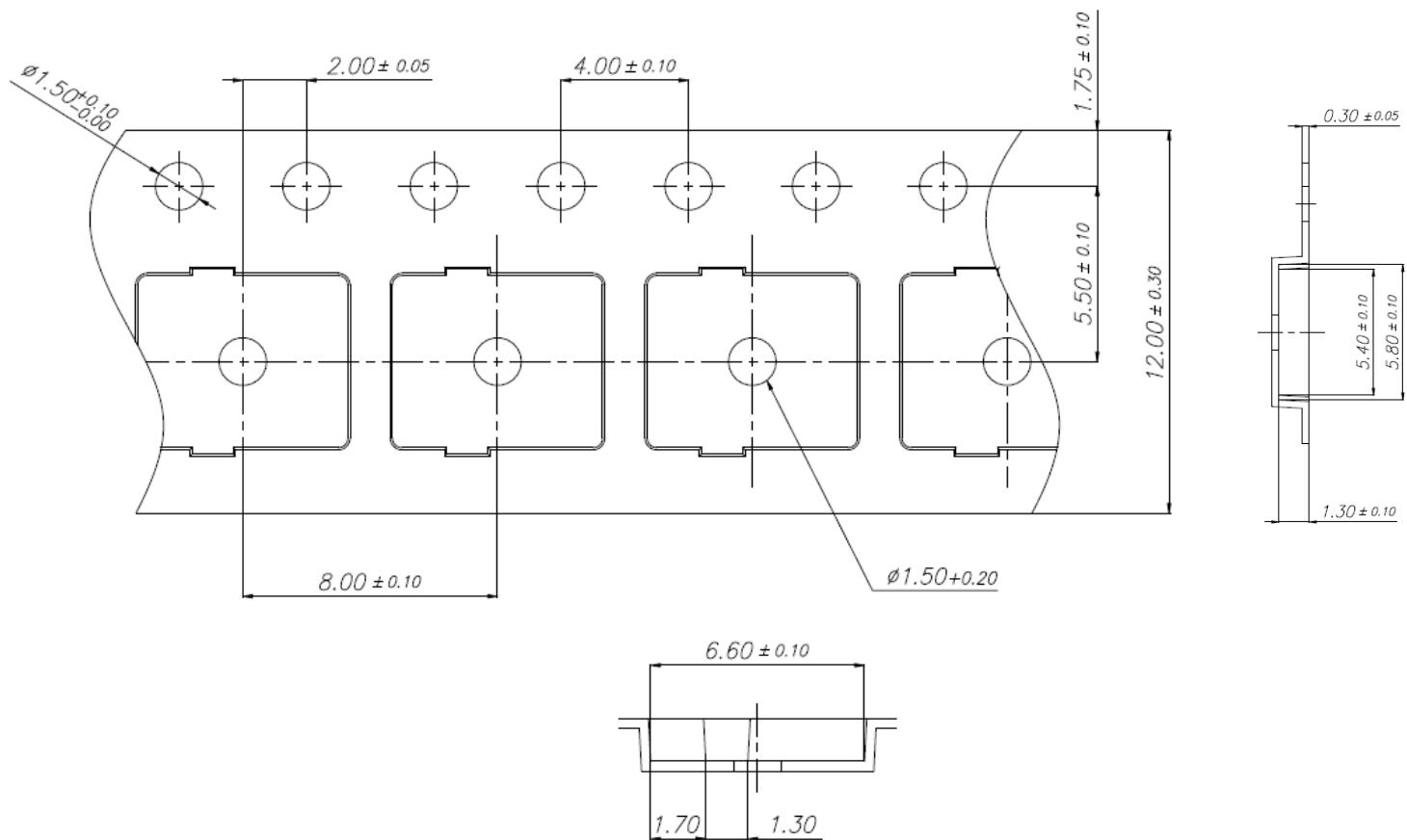


## Package Outline

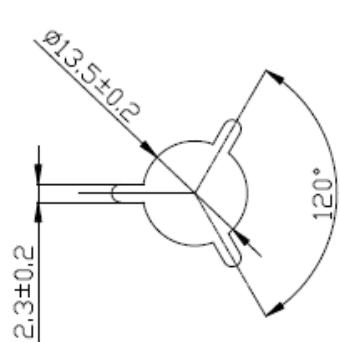
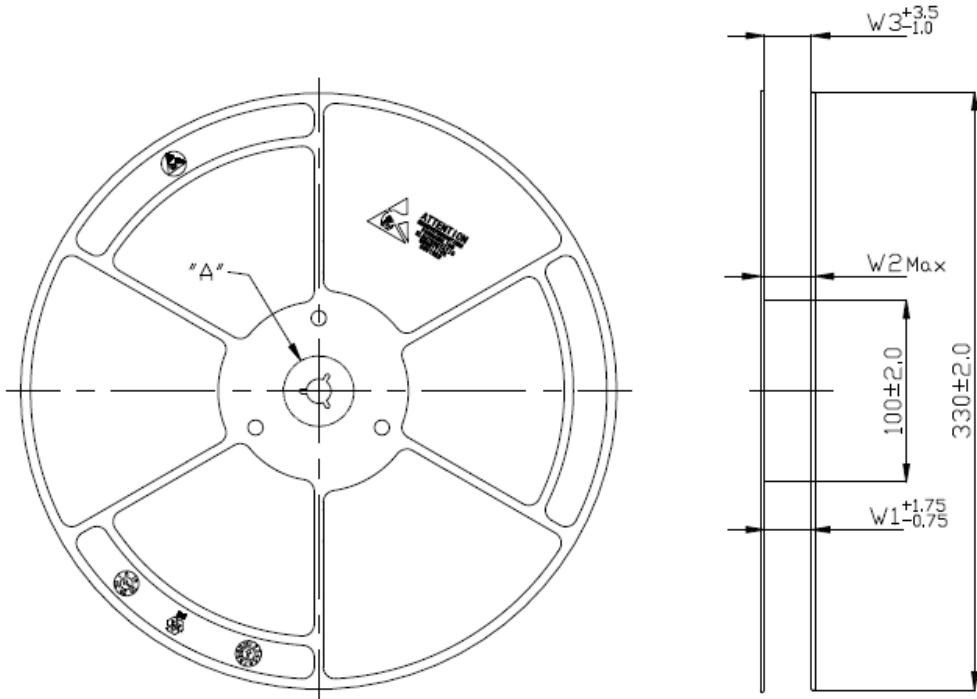


Symbol	Min	Nom	Max
A	0.95		1.05
A1	0.00		0.05
A3		0.25 REF	
b	0.31		0.51
b1	0.03		0.13
b2	0.21		0.41
D		5.15 BSC	
D1		5.00 BSC	
D2	3.7		3.9
E		6.15 BSC	
E1		6.00 BSC	
E2	3.56		3.76
e		1.27 BSC	
L	0.51		0.71
M	0.51		0.71
P	10°		12°

## Tape and Reel Orientation



## Reel and Reel Cap



“A”

$$\begin{aligned} W1 &= 13.4 \\ W2 &= 19.5 \\ W3 &= 13.4 \end{aligned}$$

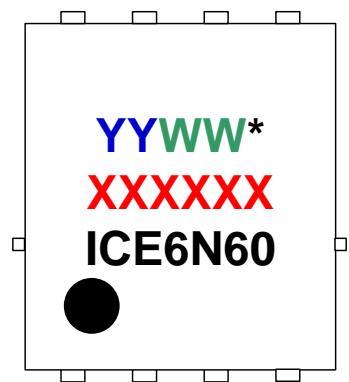
## Marking Information

**YY** = Last two digits of the year

**WW** = Work week

\* = Site ID

**XXXXXX** = Lot ID



**ICE6N60** = ICE is IceMOS logo and  
6N60 is a designated device part number

## Disclaimer

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